

# PRODUCT SPECIFICATION

**Model No.: FYLS-1206ERGBC-CC-RM**

| Features:  |
|--|
| <ul style="list-style-type: none"> <li>■ SMD Type</li> <li>■ Size (mm):3.20*1.60*1.10</li> <li>■ Emitting Color:Ultra Red/Purea Green/Ultra Blue.</li> <li>■ Lens Color: Water clear.</li> <li>■ SMT package</li> <li>■ Suitable for all SMT assembly and soldering method</li> <li>■ Pb-free Reflow soldering application</li> <li>■ RoHS Compliant</li> <li>■ MSL:4</li> </ul> |

| Applications:   |
|---|
| <ul style="list-style-type: none"> <li>■ Light Strips</li> <li>■ LCD Backlight</li> <li>■ Decorative lighting</li> <li>■ Indicators</li> <li>■ Interior automotive</li> <li>■ Illuminations</li> <li>■ Mobile Phones</li> </ul> |



| CUSTOMER APPROVED SIGNATURES | APPROVED BY | CHECKED BY | PREPARED BY |
|------------------------------|-------------|------------|-------------|
|                              |             |            |             |

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**Absolute Maximum Ratings(Ta=25°C)**

| Parameter                   | Symbol | MAX.     |     |     | Unit |
|-----------------------------|--------|----------|-----|-----|------|
|                             |        | R        | G   | B   |      |
| Power Dissipation           | PD     | 75       | 100 | 100 | mW   |
| Peak Forward Current*       | IFP    | 100      | 100 | 100 | mA   |
| Continuous Forward Current  | IF     | 30       | 30  | 30  | mA   |
| Reverse Voltage             | VR     | 5        |     |     | V    |
| Operating Temperature Range | Topr   | -40~ +85 |     |     | °C   |
| Storage Temperature Range   | Tstg   | -40~ +85 |     |     | °C   |

\*1/10 Duty Cycle, 0.1ms Pulse Width

**Typical Electrical & Optical Characteristics(Ta=25°C)**

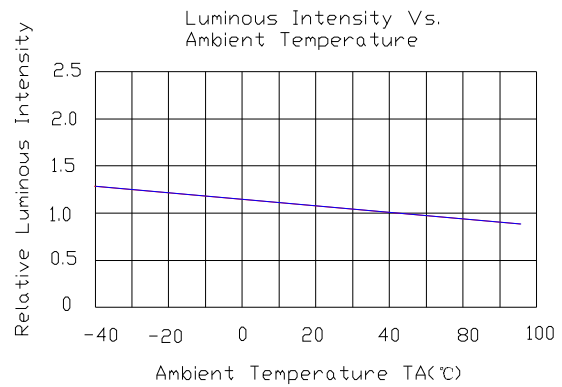
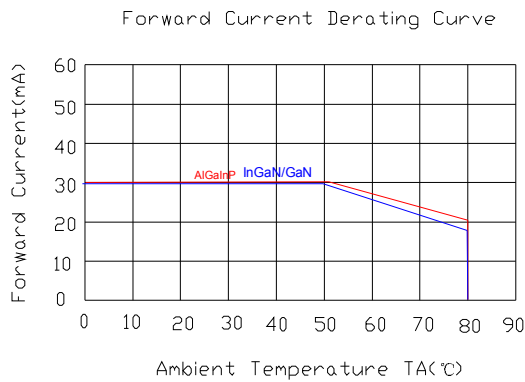
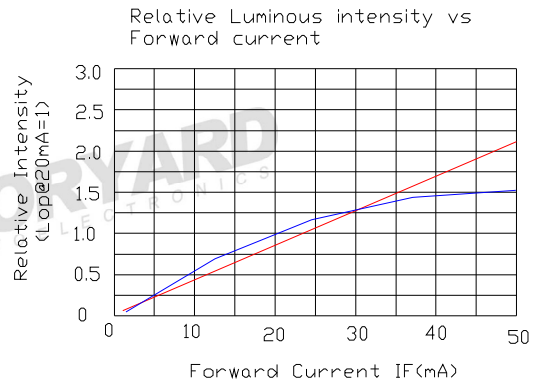
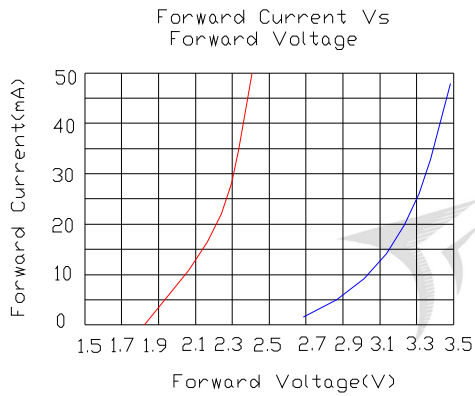
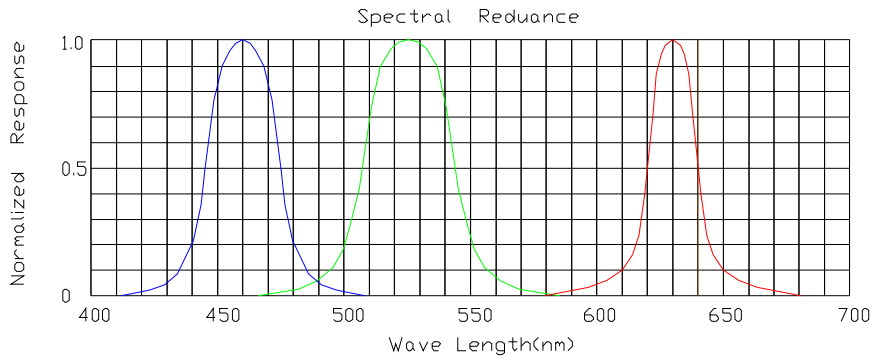
| Parameter                | Color | Symbol            | Test Condition | Min. | Typ. | Max. | Unit |
|--------------------------|-------|-------------------|----------------|------|------|------|------|
| Forward Voltage          | R     | V <sub>F</sub>    | IF=20mA        | 1.7  | 2.0  | 2.4  | V    |
|                          | G     |                   |                | 2.6  | 3.0  | 3.4  |      |
|                          | B     |                   |                | 2.6  | 3.0  | 3.4  |      |
| Peak Emission Wavelength | R     | λ <sub>p</sub>    | IF=20mA        | ---  | 630  | ---  | nm   |
|                          | G     |                   |                | ---  | 520  | ---  |      |
|                          | B     |                   |                | ---  | 460  | ---  |      |
| Dominant Wavelength      | R     | λ <sub>D</sub>    | IF=20mA        | 620  | 625  | 630  | nm   |
|                          | G     |                   |                | 520  | 525  | 530  |      |
|                          | B     |                   |                | 460  | 470  | 475  |      |
| Luminous Intensity       | R     | I <sub>v</sub>    | IF=20mA        | 180  | 300  | 650  | mcd  |
|                          | G     |                   |                | 450  | 580  | 850  |      |
|                          | B     |                   |                | 45   | 90   | 180  |      |
| Reverse Current          |       | I <sub>R</sub>    | VR=5V          | ---  | ---  | 10   | μA   |
| Viewing Angle            |       | 2θ <sub>1/2</sub> | IF=20mA        | ---  | 140  | ---  | Deg  |

**Material**

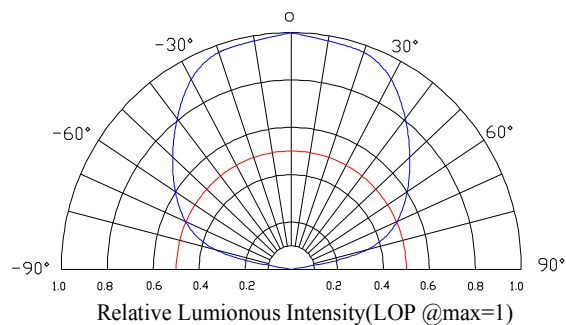
| Item     | Color | Reflector | Wire | Encapsulate | Chip      |
|----------|-------|-----------|------|-------------|-----------|
| Material | R     | /         | Gold | Epoxy       | AlGaInP   |
|          | G     |           |      |             | InGaN/GaN |
|          | B     |           |      |             | InGaN/GaN |

Note:

- 1.Luminous Intensity is based on the Foryard standards.
- 2.Pay attention about static for InGaN

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**Electrical-Optical Characteristics-**


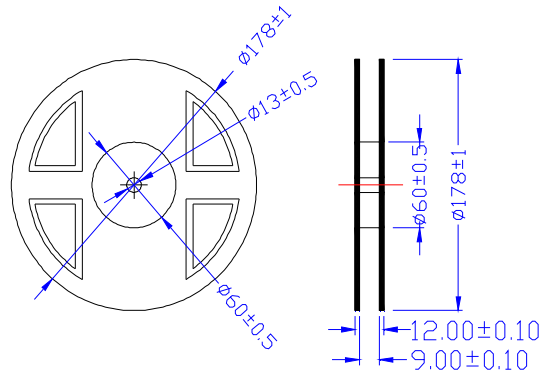
**NOTE:25°C free air temperature unless otherwise specified**

**Radiation pattern-**


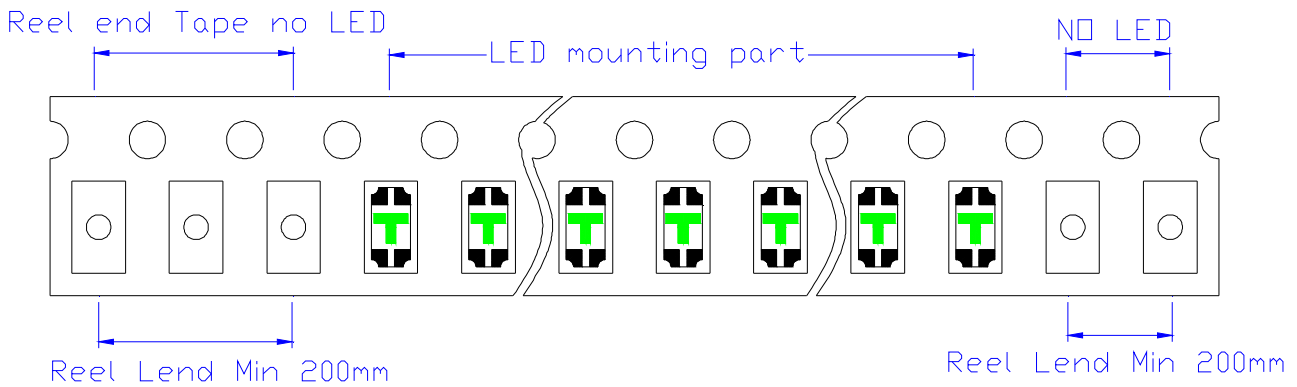
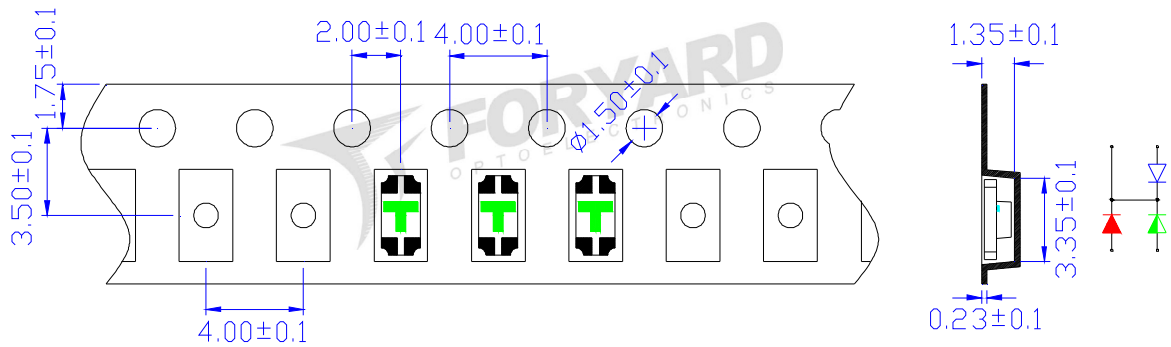
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■ Package-

1. Reel Dimension



2. Tape Dimension

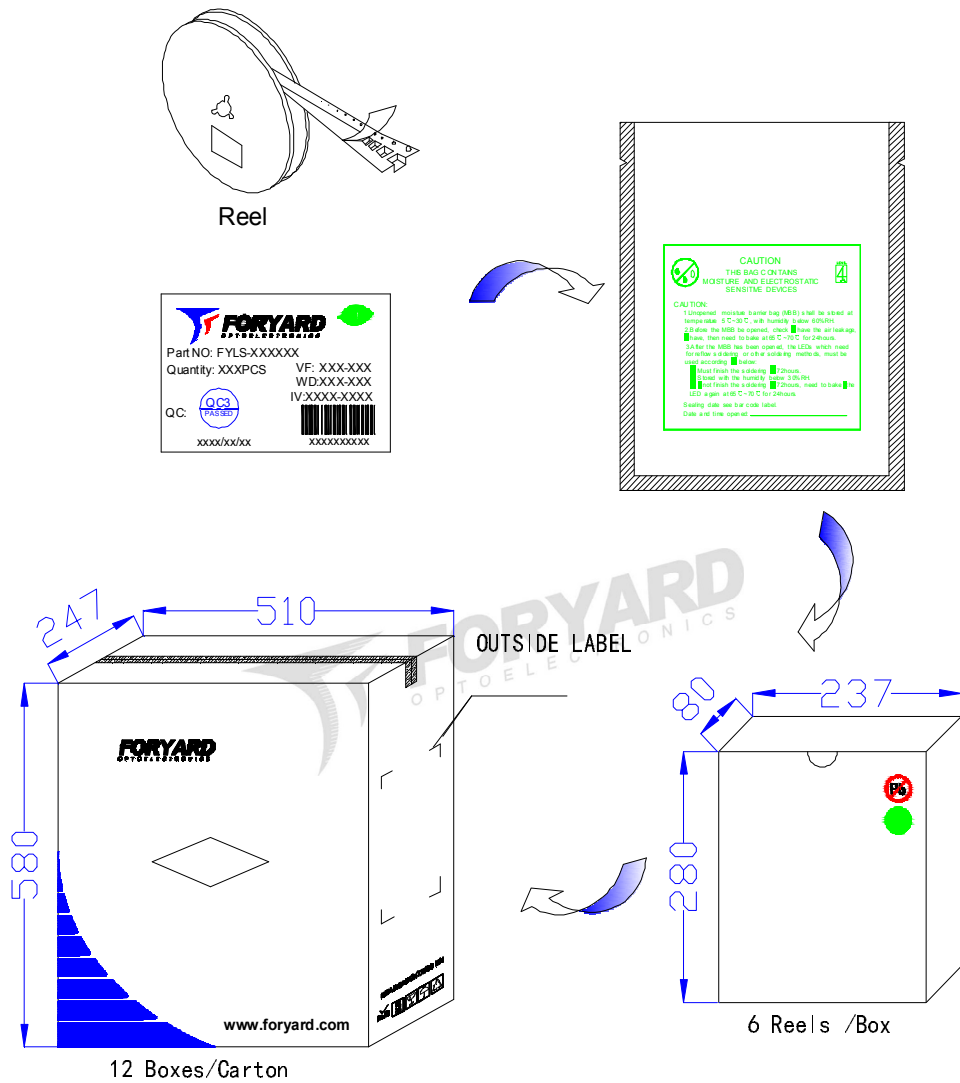



Notice:


1. Tolerance unless mentioned is  $\pm 0.2\text{mm}$

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3. Packing Diagram

**LED**  
 PN: FYLS-XXXXXXXXXX  
 Qty: XXXXX PCS  
 Date: XXXX/XX/XX  
 GW: XX.XX KG  
 NW: XX.XX KG



XXXXXXXXXX



OUTSIDE LABEL

Notice:

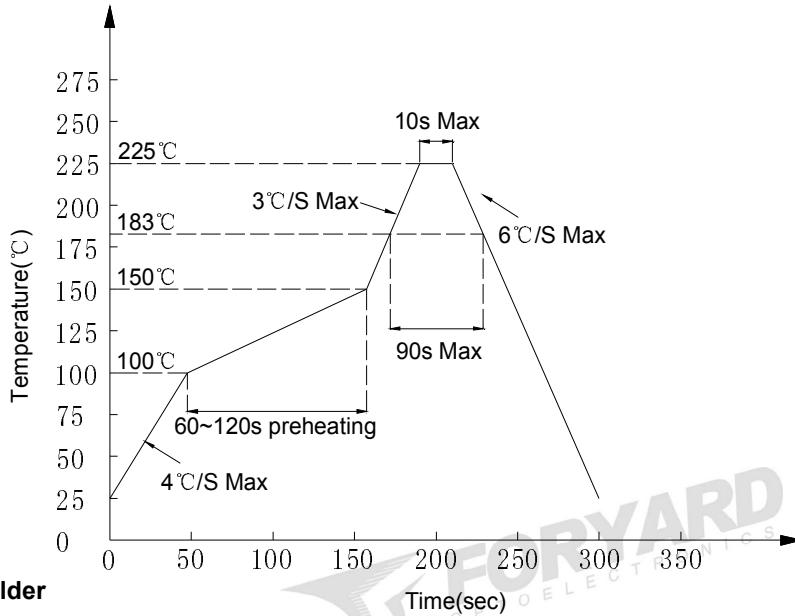
- 1.Quantity:3000 PCS/Reel
- 2.The specifications are subject to change without notice. Please contact us for updated information.

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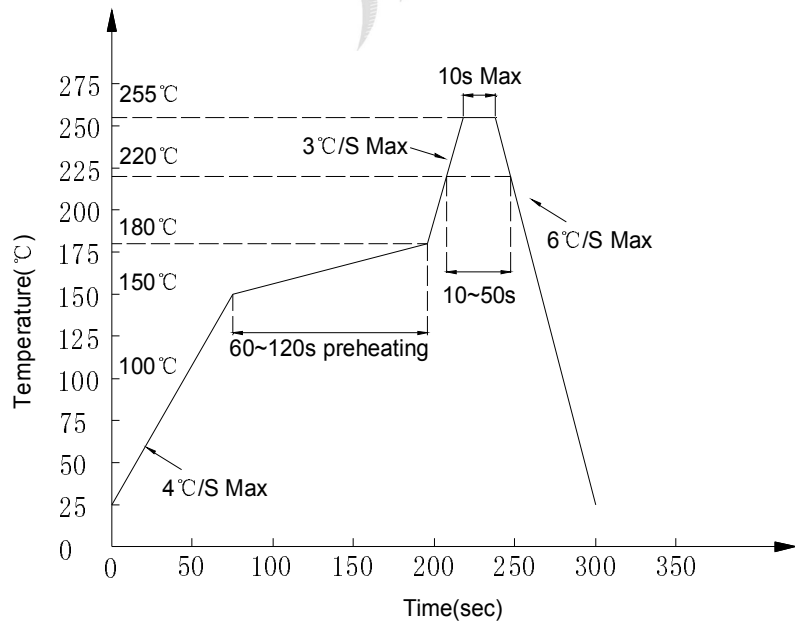
**■ Soldering Characteristics-**

**● Reflow Soldering**

**● Lead Solder**



**● Lead-free Solder**



**Notes:**

1. Although the recommended soldering conditions are specified in above table, reflow or hand soldering at the lowest possible temperature is desired for the LEDs.
2. A rapid-rate process is not recommended for cooling the LEDs down from the peak temperature.
3. All temperatures refer to solder Pad.

**● Hand Soldering**

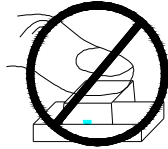
|                       |                       |               |
|-----------------------|-----------------------|---------------|
| Soldering temperature | 300°C Max. (25W Max.) | One time only |
| Soldering time        | 5 ±1sec               |               |

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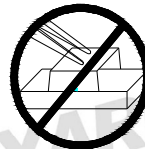
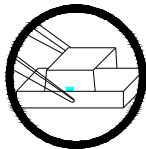
**■ Handling of Silicone Resin LEDs-**

**● Handling Indications**

When handling the product, do not touch it directly with bare hands as it may contaminate the surface and affect on optical characteristics. In the worst cases, excessive force to the product might result in catastrophic failure due to package damage and/or wire breakage.

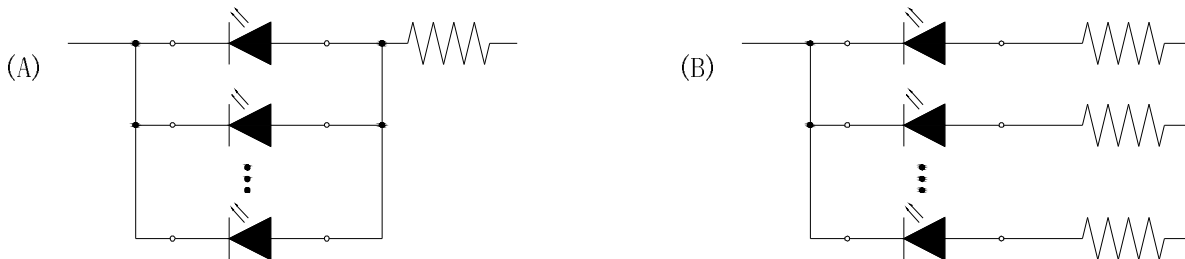


When handling the product with tweezers, LEDs should only be handled from the side and make sure that excessive force is not applied to the resin portion of the product. Failure to comply can cause the resin portion of the product to be cut, chipped, delaminated and/or deformed, and wire to be broken, and thus resulting in catastrophic failure.



**■ Recommended circuit-**

• In designing a circuit, the current through each LED must not exceed the absolute maximum rating specified for each LED. It is recommended to use Circuit B which regulates the current flowing through each LED. In the meanwhile, when driving LED with a constant voltage in Circuit A, the current through the LEDs may vary due to the variation in forward voltage (VF) of the LEDs. In the worst case, some LED may be subjected to stresses in excess of the absolute maximum rating.



• This product should be operated in forward bias. A driving circuit must be designed so that the product is not subjected to either forward or reverse voltage while it is off. In particular, if a reverse voltage is continuously applied to the product; such operation can cause migration resulting in LED damage.

**■ Storage-**

**● Storage Conditions**

1. Unopened moisture barrier bag (MBB) shall be stored at temperature below 5°C~30°C, with humidity below 60%RH.
2. Before the MBB be opened, check if have the air leakage, if have, then need to bake at 65°C~70°C for 24hours.
3. After the MBB has been opened, the LEDs which need for reflow soldering or other soldering methods, must be used according to below:
  - a: Must finish the soldering in 72hours
  - b: Stored with the humidity below 30%RH
  - c: If not finish the soldering in 72hours, need to bake the LED again at 65°C~70°C for 24hours